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## Micro-Nanostructured TiN Thin Film: Synthesis from a Photo-Patternable TiO<sub>2</sub> Sol-Gel Coating and Rapid Thermal Nitridation

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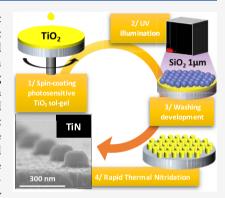
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ABSTRACT: The miniaturization of optical components to control and manipulate light amplitude, phase, and polarization requires micro- to nanostructured metasurfaces that provide resonant light—matter interactions to exploit optical properties in the visible and near-infrared (NIR) range (plasmonic resonances, wavelength filtering, etc.). Such metasurfaces sometimes need to be implemented under hard-use conditions, including high temperatures and strong field confinement. Transition-metal nitrides, like titanium nitride (TiN), are ideal materials to achieve such properties, but TiN's hardness and chemical inertness make patterning difficult. Here, we present an innovative direct fabrication process to easily synthesize a micro—nanostructured TiN thin film. The technological process is based on a direct photo-patternable titanium oxide TiO<sub>2</sub> sol—gel layer converted into TiN with a rapid thermal nitridation process. The nanoarchitecture and chemical composition of TiO<sub>2</sub> and TiN films were investigated by ultraviolet (UV)—visible—infrared (IR) spectroscopy and Raman spectroscopy, grazing incidence X-ray



diffraction (GIXRD), and high-resolution transmission electron microscopy (HRTEM) coupled with electron energy loss spectroscopy (EELS). We obtained micro-nanotextured crystallized TiN surfaces in a significantly shorter time than with conventional nitridation processes. Due to the sol-gel approach, this work also significantly extends the chances of obtaining TiN-based metasurfaces on various substrates (glasses, plastics, etc.) in complex shapes (non-planar-based surfaces), for demanding photonic applications in the future.

#### 1. INTRODUCTION

Optical metasurfaces are electromagnetic interfaces that can control and manipulate many properties of light, such as amplitude, phase, and polarization. These surfaces are composed of grating micro-nanostructures or antennas that undergo a resonant light-matter interaction with incoming electromagnetic radiation.<sup>2,3</sup> Their ability to control light locally has aroused great interest in recent years, particularly for the miniaturization of optical components. 1,4 The first metal-based optical metasurfaces were manufactured with conventional plasmonic materials such as gold and silver. However, these materials have many limitations for certain applications. Even though noble metals are good candidates for lossless plasmonic applications, silver has low chemical stability, gold is easily diffused into the substrate, and both metals have low melting temperatures. Consequently, noble metal nanostructures deform easily under high temperatures, thereby limiting their use in metasurface applications. New plasmonic materials are thus needed for stronger field confinement and high-temperature applications beyond the capabilities of noble metals. Among such materials, titanium nitride (TiN) is one of the most promising compounds investigated to date.<sup>5,6</sup> TiN can be obtained using a wide range of physical vapor deposition (PVD) and chemical vapor deposition (CVD) processes requiring

vacuum technology, such as reactive magnetron sputtering, 5,7-10 molecular-beam epitaxy, 11,12 chemical vapor deposition (CVD), <sup>13–15</sup> atomic layer deposition (ALD), <sup>16–19</sup> or pulsed laser deposition (PLD)<sup>20–22</sup> under a nitrogen or ammonia atmosphere. Unfortunately, due to its intrinsic properties, notably hardness and chemical resistance, TiN cannot easily form micro- and nanostructures. Structuring techniques using lithography and liftoff and/or physical or chemical etching processes do exist<sup>21</sup> but are restrictive and time-consuming. The size and shape of the substrates are also limiting for these techniques since they are constrained to planar microelectronic technologies. Another recent method consists of performing micro-nanostructuring on a TiO<sub>2</sub> sol-gel photopatternable film that is then converted into TiN using a thermal nitridation process in an ammonia atmosphere.<sup>23</sup> The main advantage of the sol-gel-based processes is that they make it possible to achieve submicronic structuration with various

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reproducible shapes (like grating, 23 pillars, 24 etc.) on large surface areas<sup>24</sup> and without unconventional shape restrictions. 25,26 Generally, nitridation processes of TiO<sub>2</sub> films are achieved in traditional ovens with a long exposure time at high temperatures (more than 900–1000 °C for several hours),<sup>27</sup> which limits their use for stable substrates at high temperatures and also limits their industrial deployment. Rapid thermal nitridation (RTN) appears to be a very promising alternative way to synthesize high-quality TiN sub-microstructured thin films with complex shapes on a wide range of substrates at significantly shorter heating times and under less stringent conditions. Here, we demonstrate how to obtain micronanostructured TiN films by combining a direct ultraviolet (UV)-photolithography process with rapid thermal nitridation from a photo-patternable TiO<sub>2</sub> sol-gel coating using a low-cost, reproducible process that is compatible with large substrate areas and different shapes. For example, this technique could be potentially useful in the manufacturing of optical metasurface devices or new plasmonic materials.

### 2. EXPERIMENTAL SECTION

**2.1. Elaboration of TiO<sub>2</sub> Films.** The films used in this study were elaborated following a previously published procedure. 23,24,30,31 To optimize photo-patternable films, two sols were mixed. The first sol (sol 1) was prepared by reacting tetraisopropylorthotitanate (TIPT from Fluka) with benzoylacetone (BzAc from Aldrich) in methyl alcohol (MeOH from Prolabo). The TIPT/BzAc/MeOH molar composition was 1/ 0.91/20.4. The second sol (sol 2) was prepared by mixing TIPT with deionized water, hydrochloric acid (HCl from Roth), and butyl alcohol (BuOH from Alfa Aesar) as a solvent. The TIPT concentration in the solution was 0.4 M, and the TIPT/H<sub>2</sub>O/ HCl/BuOH molar composition was 1/0.82/0.13/23.9. The photo-patternable solution was prepared by mixing sols 1 and 2 to obtain a final sol with a TIPT concentration of 0.6 M and a BzAc/TIPT molar ratio of 0.6. The sol was deposited on a silicate substrate by spin-coating at 3000 rpm for 1 min. The resulting sol-gel film was heated at 110 °C for 90 min, resulting in a so-called xerogel film, i.e., an inorganic polymer film made of Ti-O-Ti chains with organic chain-end groups arising from the sol formulation, mainly TIPT-BzAc complexed species. The thickness of the resulting thin-film layer was close to 300 nm.

2.2. Film Photo-Structuring Process. The xerogel films are soluble in different solvents (alcohol, chloroform, acetone, etc.) as long as BzAc remains complexed with TIPT. The main strength of this protocol is the properties of BzAc, which make the film soluble in a solvent while remaining sensitive to UVA light. Indeed, under UVA illumination, the TIPT-BzAc complex is partially degraded into insoluble species such as carbonates and/or carboxylates. It therefore creates a contrast of solubility between illuminated and nonilluminated areas when it is spatially selectively exposed to UVA light, such as a negative photosensitive layer. In our first experimental demonstration, microstructuring films were obtained by illuminating xerogel films through a chromium photomask for 5 min under a 365 nm wavelength collimated light, from a UV photomask exposure machine (SET 700 photomask machine) with an irradiance of 26 mW·cm<sup>-2</sup>, which led to the production of linear gratings of 1  $\mu$ m period. The photochemical or thermochemical effects of this step process are described in previous work.<sup>30</sup> In the present study, the nanostructured TiO2 films were made using microsphere photolithography to obtain amorphous TiO<sub>2</sub> nanopillars, according to the procedure published in ref 24.2

The Langmuir-Blodgett (LB) technique was used to deposit a 1  $\mu$ m silica microsphere monolayer with an acrylate surface (suspension in ethanol (96% v/v) Micromod) on an amorphous TiO<sub>2</sub> xerogel film using an LB machine (KSV NIMA LB) from Biolin Scientific. The subphase was made using deionized water. The monolayer of silica microspheres was spread on the aqueous subphase at room temperature. The monolayer was left for 10 min for the solvent to evaporate. After compression of the silica microsphere monolayer at a barrier speed of 2 mm min<sup>-1</sup>, LB was deposited on the TiO2 thin film (deposited on a SiO2 substrate) at a surface pressure of 35 mN·m<sup>-1</sup> using the dipping method at a withdrawal speed of 1 mm min<sup>-1</sup>. After the homogeneous deposition of two-dimensional (2D) hexagonal microspheres, the films were first illuminated with homogeneous UV light to create the nanopillars according to a 2D hexagonal microsphere pattern. The exposure film was then developed by soaking it in ethanol for 30 s and finally rinsing it in deionized water for a further 30 s. Ethanol dissolves the noninsolated xerogel layer and water stabilizes it, leading to a pattern that is the same as the one of the photomask, or in the case of the microsphere photolithography, leading to nanopillars. The amorphous-structured TiO2 thin film was then nitrided by rapid thermal annealing (RTA) under NH3 gas. According to Kamiya et al., 27,32 the nitridation under heating is performed via the following reactions of NH3 with the reduced titanium

$$2NH_3 \rightarrow N_2 + 3H_2 \tag{1}$$

$$2\text{TiO}_2 + \text{H}_2 \rightarrow \text{Ti}_2\text{O}_3 + \text{H}_2\text{O}$$
 (2)

$$Ti_2O_3 + 2NH_3 \rightarrow 2TiN + 3H_2O$$
 (3)

Rapid thermal nitridation treatment of this film was done using an RTA As-One 100 furnace from Annealsys under pure  $\rm NH_3$ . Samples are treated in a reproducible and uniform way using a system of 12 high-intensity halogen near-infrared (NIR) light sources. Initially, the reactor was purged with a cycle of  $\rm N_2$  (1000 sccm) and vacuum. We use the RTA furnace with a configuration that unfortunately does not allow us to know precisely the temperature used during our process, which is why we only indicate a percentage of lamp power. The samples are irradiated for 30 s at 30% lamp power 10 times in a row (with a 1 s at 1% lamp power between each heat treatment to preserve the lamps and maximize their lifetime) for a total NIR exposure time of 10 min. During the nitridation process, a 1000 sccm NH $_3$  flow was introduced in the chamber at a pressure of 10 mbar.

2.3. Characterization. Several characterizations were performed to identify both the optical properties and structural/material properties of the resulting non-microstructured and microstructured thin films. The films were characterized before and after nitridation. UV-visible (vis)infrared (IR) spectrophotometric measurements (Cary 5000 UV-vis-NIR from Agilent Technologies) were performed in the infrared, visible, and near-UV spectral ranges. Reflection spectroscopy measurements were carried out in specular configuration with an incident angle of 10°. Raman microspectroscopy measurements (LabRam ARAMIS) were performed with excitation at 633 nm. Grazing incidence X-ray diffraction (GIXRD) was carried out to obtain a surfacesensitive diffraction signal representative of the crystalline structures of the Ti-based thin films. Measurements were obtained using a PANalytical MPD diffractometer delivering an X-ray beam produced by a copper anti-cathode with a

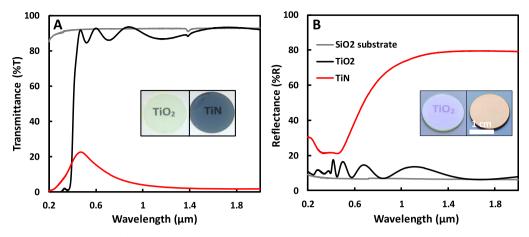


Figure 1. UV—visible—NIR reflectance (A) and transmittance (B) spectra of the glass substrate (SiO<sub>2</sub>), TiO<sub>2</sub>, and TiN thin films. Inset: A and B optical photographs of the same TiO<sub>2</sub> and TiN thin films in transmission and specular reflections, respectively.

wavelength of 0.154 nm. Acquisition was performed in the  $2\theta$ mode within 30 and 80°. Spectroscopic ellipsometry measurements (UVISEL from Horiba Jobin Yvon, associated with DeltaPsi2 software) were made to determine the refractive index (n) and the extinction coefficient (k) to deduce the corresponding  $\varepsilon'$  and  $\varepsilon''$  values of permittivity of the TiO<sub>2</sub> and TiN thin films. The surface roughness was determined using a Dimension Icon from Bruker AFM and the thickness of the film was measured with a profilometer Veeco Dektak 3 ST. Structural and chemical investigations were conducted with electron microscopy. First, focused ion beam (FIB) lamellas were extracted from the two samples using an FEI (Thermo Fisher) Helios 600i dual-beam FIB/scanning electron microscopy (SEM). The two lamellas were thinned at different Ga<sup>+</sup> ion voltages and currents, and were finally thoroughly cleaned down to 1 kV to optimally remove ion beam artifacts, such as redeposition or amorphization. Then, bright-field transmission electron microscopy (BF-TEM), high-angle annular dark-field scanning TEM (HAADF STEM), and high-resolution TEM (HRTEM) pictures were produced on the lamellas using a JEOL Neo-ARM 200F transmission electron microscope. The Neo-ARM is a spherical aberration (Cs)-corrected TEM, equipped with a cold-field electron gun (cold-FEG). Electron-dispersive spectroscopy (EDS) was performed on both samples using a JEOL large-angle silicon drift detector (1sr SDD CENTURIO-XL). EDS mappings of nitrogen, oxygen, silicon and titanium were performed using the same ROI in the range of 0.36-0.45, 0.49-0.56, 1.64-1.84, and 4.35-4.67 kV, respectively. Electron energy loss spectroscopy (EELS) and spectrum image (SI) data were collected in EELS mode together with HAADF STEM using a Gatan imaging filter (GIF Quantum ER) and a Gatan ADF STEM detector. Spectra and mapping were aligned and extracted from the dual-EELS SI raw data; the appropriate background was selected using DM software.

## 3. RESULTS AND DISCUSSION

**3.1. Characterization of Titania Films.** After deposition, the  $TiO_2$  films were transparent and slightly yellowish (Figure 1A). UV-vis-NIR transmittance analyses (black curve in Figure 1A) revealed a typical strong absorption band for the  $TiO_2$  thin film under 400 nm, indicating its opacity in the UV region and hence its absorption in the UV wavelength range. The curve of the film presents no other absorption band in the visible and near-infrared range, with a maximum transmittance

higher than 80%, indicating its transparency in this region. The oscillations present on the curve are due to the interference of the reflection of the light on the transparent substrate and film interfaces. This phenomenon depends on the refractive indexes and the thickness of the film.<sup>33</sup> The reflectance curve agrees with the results in the transmission as shown in Figure 1A, with a reflectance lower than 20% and a slight purple color in reflection.

The thickness of the titania (TiO<sub>2</sub>) film is estimated to be 300 nm from profilometry measurements and TEM pictures in cross section (Figure 4). Their Raman spectrum (Figure 2) shows

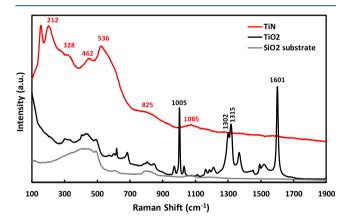
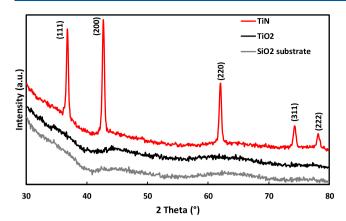


Figure 2. Raman spectra of a bare glass substrate ( $SiO_2$ ),  $TiO_2$ , and TiN thin films.

multiple peaks but no features of crystallized  $TiO_2$ . According to Oda et al., the strong peaks at 1601 and 1005 cm<sup>-1</sup> are assigned to 8b and 12 vibration modes of the phenyl group of BzAc, and the peaks at 1302 and 1315 cm<sup>-1</sup> can be attributed to C=C=C symmetric vibrations in chelating rings.<sup>34</sup> The other weak Raman peaks are hypothesized to be related to the BzAc or  $TiO_2/BzAc$  complex. It is clear from these results that the  $TiO_2$  layer is not pure and still contains organic functions, but to simplify the reading, we will retain the name  $TiO_2$  in the rest of the paper for xerogel comprising organic functions.

Grazing incidence X-ray diffraction (GIXRD) measurements (Figure 3) confirmed the absence of diffraction peaks related to crystallized phases of titania, indicating the amorphous character of the titania film (diffractogram in black). The diffractogram related to the amorphous silica substrate is also shown in Figure 3 (diffractogram in gray).



**Figure 3.** GIXRD patterns for a bare glass substrate ( $SiO_2$ ), amorphous  $TiO_2$ , and TiN thin films.

The amorphous nature of the  ${\rm TiO_2}$  film can be inferred from EELS SI data (Figure 4). Indeed, the  ${\rm Ti\,L_{2,3}}$  edges at 456 and 462 eV are characteristic of the amorphous phase of  ${\rm TiO_2}$ . Furthermore, the spectrum shows slightly shouldered  ${\rm Ti\,L_{2,3}}$  edges that nevertheless indicate the presence of some nanocrystals in the film. Some Consequently, before irradiation, the films are considered to be homogeneous and mainly amorphous.

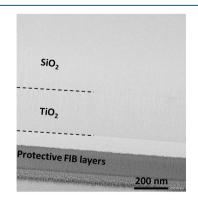
Spectroscopic ellipsometry measurements were performed to determine the optical constants of the films for wavelengths between 280 and 2000 nm. The refractive index of the  $TiO_2$  amorphous thin films (Figure 5A) is estimated at around n=2 and 1.7, respectively, in the visible region (for  $\lambda=400$  nm) and the near-infrared region (for  $\lambda$  from 1100 to 2000 nm). Atomic force microscopy (AFM) measurement showed that the film has a relatively homogeneous morphology with a smooth surface. The calculated roughness is approximately Ra  $\approx 22$  pm.

**3.2.** Conversion of a Titania Film into a Titanium Nitride Film. The xerogel films are subjected to a cycle of ten 30 s infrared flashes under a flow of ammonia at a flow rate of 1000 sccm and a pressure of 10 mbar. After treatment, the films are slightly transparent. They are grayish in color in transmission (Figure 1A) and have a burnished color in reflection (Figure 1B). The thickness of the TiN films is around 60 nm, which is thinner than that of the amorphous TiO<sub>2</sub> layers heated at 110 °C (250 nm). The increase in the annealing temperature during the RTN causes densification of the film and thus reduces the thickness of the film. This densification causes a global shrinkage of around 75% of the original volume. The reflectance spectra indicate a minimum reflectance of 21% at wavelengths between

300 and 500 nm and a high reflection around 80% in nearinfrared wavelengths, revealing a change in the optical properties of the original film. This high reflectance in near IR highlights the metallic character of TiN<sup>37</sup> compared to the pure dielectric behavior of the TiO<sub>2</sub> layer. The transmittance spectrum of the TiN thin film confirmed these results with a broad absorption peak at wavelengths around 480 nm with a maximum transmittance of 22% and then decreased to 1-2% in the near-infrared region. The broad absorption signal in the visible region due to the incorporation of nitrogen into the film agrees with the gray coloring of the TiN sample. The spectroscopic ellipsometry measurements confirmed this statement; the refractive index changed at n = 5 for  $\lambda = 2000$  nm (Figure 5B). These results resemble those reported by Pflüger et al. 36 for stoichiometric TiN. The real part of the refractive index (n)differs slightly from the bulk value of the TiN, which can be explained by the porosity in the layer that reduces the real part of the refractive index. The k value of the refractive index demonstrates absorption of the TiN thin layer, while it is equal to zero for the TiO2 thin layer in the visible wavelength range. From ellipsometry measurements, we can also deduce the corresponding values of the real  $(\varepsilon')$  and the imaginary  $(\varepsilon'')$ parts of permittivity with eq 4 as follows

$$\varepsilon' = n^2 - k^2 \quad \varepsilon'' = 2n^2 k^2 \tag{4}$$

The latter parameters are very important to confirm that the layer is a good material for the propagation of plasmonic waves since they determine the metallic properties of the layer. The  $\varepsilon'$ and  $\varepsilon''$  values measured on the TiN layer as a function of the wavelength are illustrated, respectively, in Figure 6A,B. Our TiN film presents the lowest real permittivity  $\varepsilon' \approx -14$  for  $\lambda = 1600$ nm. The metallic property was estimated with the absolute value of the real part of the permittivity  $(\varepsilon')$  to be as large as possible. Concerning the imaginary part of the permittivity,  $\varepsilon''$  evolves almost linearly as a function of the wavelength up to  $\varepsilon'' = 60$  for  $\lambda$ = 2000 nm. We observe a lower metallic character in our TiN film compared to recent reports of plasmonic TiN obtained by the physical deposition method that may negatively affect the performance of the plasmonic metasurface that is fabricated out of them. <sup>21,38</sup> This could be explained by the fact that our films present higher residual porosity due to the preparation method; the films prepared by the sol-gel route are generally less dense than those obtained by physical route deposition. As shown in the cross-sectional HAADF STEM images in Figure 7A, one can see a few pores that could explain the lower values of optical properties. This difference in density in our films could explain the lower metallic character in our TiN layer. The metallic



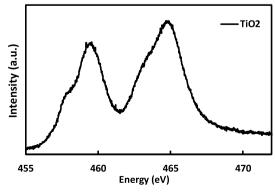
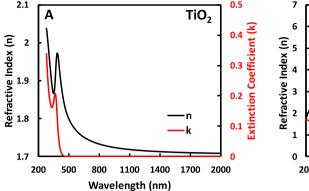


Figure 4. Cross-sectional high-resolution transmission electron microscopy image (left) and EELS spectrum (right) of the amorphous TiO<sub>2</sub> thin film.



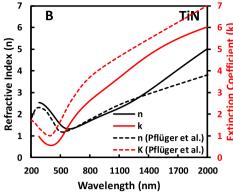
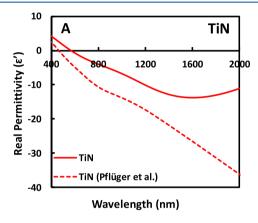


Figure 5. Refractive index (n), extinction coefficient (k) spectra of amorphous  $TiO_2(A)$ , and TiN(B) thin films compared with the values reported by Pflüger et al. <sup>36</sup>



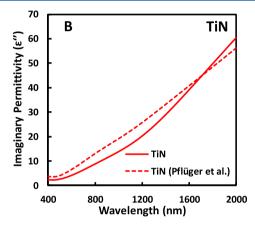
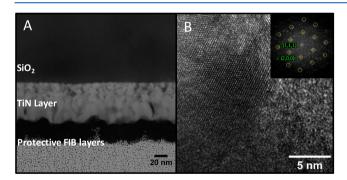


Figure 6. Permittivity according to the wavelength for a TiN film: (A) real part ( $\varepsilon'$ ) and (B) imaginary part ( $\varepsilon''$ ) compared with the values reported by Pflüger et al.<sup>36</sup>



**Figure 7.** (A) Cross-sectional high-magnification HAADF STEM image of the TiN thin film and (B) HRTEM image of the same TiN layer. Inset: corresponding fast Fourier transform (FFT) showing the (111) and (200) directions of the TiN FCC structure.

properties could be improved by reducing the porosity in our TiN layer, for example, by optimizing the preparation of the  ${\rm TiO_2}$  solution or/and the nitriding conditions. In spite of this, these results enable us to conclude that the TiN layer could be used as a plasmonic layer in the NIR range, with reasonable losses, caused by the propagation length of the surface plasmon propagating along the metallic layer.

However, the roughness increases very slightly at Ra  $\approx 181$  pm; the films therefore remain relatively flat and homogeneous. The Raman spectra carried out after RTA treatment revealed the presence of six dominant peaks at 212, 328, 462, 536, 825, and 1 085 cm<sup>-1</sup> (Figure 2). These values agree with the Raman-active modes of titanium nitride (TiN) reported in the literature. <sup>39–41</sup> The bands at 212 and 328 cm<sup>-1</sup> are attributed to transverse acoustic (TA) and longitudinal acoustic (LA) modes, the band at 462 cm<sup>-1</sup> to the second-order acoustic (2A) mode, and the band at 536 cm<sup>-1</sup> to the transverse optical (TO) mode of the

Table 1. Experimental  $d_{(hkl)}$  and Relative Intensity I (%) Values of the Investigated Titanium Nitride Film, Compared to the  $d_{(hkl)}$  and I (%) Values Related to the Osbornite TiN Reference 42 a

	(111)	(200)	(220)	(311)	(222)
d <sub>(hkl)</sub> experimental (nm)	0.243963	0.211357	0.149461	0.127542	0.122137
$d_{(hkl)}$ osbornite TiN (nm)	0.243988	0.211300	0.149412	0.127419	0.121994
(d experimental—d osbornite)/d osbornite (%)	-0.01%	+0.03%	+0.03%	+0.10%	+0.12%
I (%) experimental	77.7	100.0	53.7	18.9	12.4
I (%) osbornite TiN	71.2	100.0	45.6	17.6	11.6

<sup>&</sup>lt;sup>a</sup>Relative shift between experimental  $d_{(hkl)}$  and osbornite  $d_{(hkl)}$  is also depicted for the five diffraction peaks.

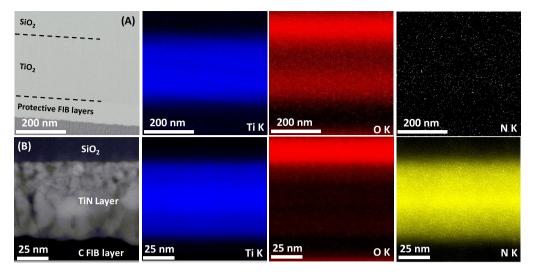


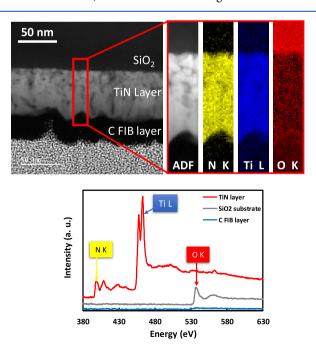
Figure 8. Cross-sectional high-resolution transmission electron microscopy image and EDS mapping images of the thin films related to (A) Ti, O, and N elements in the  $TiO_2$  film and (B) Ti, O, and N elements in the TiN film.

TiN film. The two broad peaks at around 825 and 1 085 cm<sup>-1</sup> could be assigned to LA + TO and 2TO modes of TiN, respectively. The RTN process causes shrinkage, resulting in a film that is about 50 nm thick. The significant reduction in the thickness of the film results from the switch of the film from amorphous TiO2 to TiN. This structural transformation is also observed by GIXRD measurements, as shown in Figure 3. The GIXRD diffractogram related to the coating after irradiation by the infrared flashes under the ammoniac flow exhibits five diffraction peaks centered at  $2\theta = 36.8115$ , 42.7480, 62.0465, 74.3080, and 78.2016°. After background subtraction, their relative intensities normalized to the most intense peak (42.7480°) are 77.7, 100.0, 53.7, 18.9, and 12.4%, respectively. The Bragg indexation of those five peaks corresponds to a cubic phase with a space group  $Fm\overline{3}m$  (225), with a cell parameter of 0.4235 nm. The most probable phase in agreement with this space group and cell parameter value is titanium nitride (TiN), whose diffraction peaks within the investigated diffraction range correspond to the crystalline planes (111), (200), (220), (311), and (222). Table 1 compares the experimental  $d_{(hkl)}$  and relative intensity I (%) values with those related to osbornite TiN as the reference crystalline phase.<sup>42</sup> The relative shift between experimental and osbornite diffraction peaks (d experimentald osbornite)/d osbornite, depicted in Table 1, ranges within -0.01% and +0.12%, which demonstrates that the experimental TiN film is very similar to natural osbornite from a crystallographic point of view. The small shift may be attributed to some internal stress, whose quantification has not been investigated at the present stage of experimentation. The good agreement between the  $d_{(hkl)}$  and I (%) values of the investigated film and the reference TiN crystal indicates that the infrared flash irradiation of titania in the presence of ammonia unambiguously leads to the formation of a crystallized titanium nitride film.

The conversion of the titania film into the titanium nitride film is also confirmed by HRTEM diffractograms (Figure 7B) obtained on crystals inside the film, indicating the presence of a TiN crystalline phase (face-centered cubic (fcc) structure with a unit cell length of 0.4235 nm),  $^{43}$  in agreement with the results of previous GIXRD investigations.

The cross-sectional HAADF STEM images in Figure 8A,B show well-defined  ${\rm TiO_2}$  and  ${\rm TiN}$  layers whose respective thicknesses are in agreement with profilometry measurements

(around 250 nm for  $TiO_2$  and 60 nm for TiN). Figure 8A,B also shows the results of the STEM/EDS element mapping carried out on the  $TiO_2$  sample before and after RTN treatment. We can observe before nitridation a slight oxygen concentration gradient along the z-axis, which does not affect the quality of the layer after treatment under NH<sub>3</sub>. Currently, we do not know the causes of this gradient but studies are underway. EDS mapping of titanium, oxygen, and nitrogen on both samples (Figure 8) confirmed that the nitridation process was complete throughout the layer. These results are in full agreement with the EELS experiments carried out on the nitrided sample (Figure 9). Indeed, the energy loss spectrum corresponding to the nitrided sample shows, respectively, an N K edge at 401 eV, a  $Ti L_{2,3}$  edge at 456 and 462 eV, and a reduced O K edge at 532 eV. EELS



**Figure 9.** Top: cross-sectional HRTEM of the TiN thin film, annular dark field (ADF), and element mapping images for the N, Ti, and O elements in the TiN layer. Bottom: corresponding EELS spectra of  $SiO_2$ , TiN, and the protective FIB layer.

experiments allow us to explain the oxygen EDS signal detected on the nitrided sample. The EELS oxygen mapping based on the oxygen K edge shows a predictable strong signal in the SiO<sub>2</sub> substrate. Nevertheless, an oxygen K edge was detected everywhere on the FIB lamella, including on the TiN film and on the carbon-protective carbon layer. With respect to the weaker intensity of the O K edges on the TiN layer and the protective FIB layers, one can reasonably assume that both the top surface of the TiN layer and the entire surface of the FIB lamella are contaminated by ambient oxygen following the nitridation process and the final FIB lamella step, respectively. The elemental composition of the TiN film was also determined using the EELS Hartree-Slater model. The estimated atomic percentages of each element in the film are 35% for Ti, 64% for N, and less than 1% for O. To conclude, EELS data together with EDS characterization provide further evidence that the layer was entirely nitrided in the form of TiN following the nitridation process.

**3.3. Microstructuring of Titanium Nitride Films.** In the following section, we demonstrate the complete process of direct TiN layer microstructuring from a TiO<sub>2</sub> sol–gel-based thin-film layer. We demonstrate that this approach is compatible since the process starts from a direct photo-patternable TiO<sub>2</sub> sol–gel. This process has the advantage of being able to rapidly transform TiO<sub>2</sub> into TiN and to avoid annealing in thermal ovens, meaning that the process should be feasible on a wide range of substrates. However, the benefit of this technique goes beyond the diversity of substrates because sol–gel TiO<sub>2</sub> can be easily structured by UV exposure, making it possible to obtain TiN (sub)micronic-structured thin films with complex shapes after nitridation. Figure 10A,D shows two patterns in TiO<sub>2</sub>

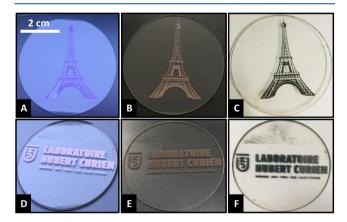


Figure 10. Photographs of structured  $TiO_2$  thin films after UV exposure through photomasks with a slight purple color in reflection (A, D) and photographs of the same structured films after nitridation with a burnished color in reflection (B, E) or with a grayish color in transmission (C, F). The thickness of the microstructured  $TiO_2$  sol—gel is around 300 nm and the obtained thickness of the microstructured TiN layer is around 70 nm, which explains the partial transmittance when one looks at the microstructured substrate in transmission.

obtained by UV exposure of a xerogel film through a photomask. The patterns resemble the original photomask. These patterns of  ${\rm TiO_2}$  are then nitrided by the RTA process, described in the previous sections. After treatment, a replica in TiN of the photomask is obtained (Figure 10B,C,E,F). The whole process takes around 20 min from the deposition of the  ${\rm TiO_2}$  xerogel to the final nitridation step.

3.4. Nanostructuring of Titanium Nitride Films. To complete the previous discussion, the following section demonstrates the spatial resolution that can be obtained to produce submicron patterns in TiN, which is finally given by TiO<sub>2</sub> sol-gel-based lithography. Figure 11A shows the nanostructured TiO<sub>2</sub> thin film after UV ( $\lambda = 365$  nm) illumination and development of the xerogel layer, revealing periodically organized nanopillars that are cylindrical in shape. 24,25 These nanopillars appear to be fairly regular with dimensions of around 300 × 500 nm, in agreement with AFM measurements (Figure 11B). The AFM profile also identified a periodicity of about 1  $\mu$ m induced by the 1  $\mu$ m diameter silica microspheres that are in contact with one another during LB deposition. Higher density of the structure can be envisaged using silica nanospheres with a smaller diameter. After the nitridation step, the AFM measurements (Figure 11C,D) clearly showed the densification effect due to the rapid thermal process. This densification leads to smaller TiN nanopillars with a height of around 80 nm and a diameter similar to those of the TiO<sub>2</sub> nanopillars.

### 4. CONCLUSIONS

In this article, we presented an innovative and direct process to structure TiN thin films involving a directly photo-patternable TiO2 sol-gel layer, which, to our knowledge, has never been published to date. The UV-vis-NIR, Raman, and GIXRD investigations indicated that the structured thin film elaborated from rapid thermal nitridation (RTN) of amorphous TiO2 led to a pure face-centered cubic structure TiN with weak roughness and a thickness of around 60 nm. The extremely low oxygen content highlighted by the EDS, HRTEM, and EELS results confirmed the formation of a film close to a TiN reference film, and not TiO<sub>x</sub>N<sub>y</sub> as obtained in previous studies using a conventional nitridation process.<sup>23</sup> This has been also demonstrated with ellipsometry measurements, giving almost the same permittivity as that of pure TiN obtained by traditional process deposition. From this study, we have shown that this new nitridation process leads to a TiN layer with interesting properties, even if the optical and metallic characteristics are rather in the lower range of usual TiN films obtained by the physical route. 12 The residual porosity, inherent to the sol-gel route, coupled with the low thickness of the TiN layer, could explain these lower values. Further studies on the nitriding conditions could be carried out to improve the material properties. The main advantage of this method over traditional ammonolysis is how easy it is to produce the TiN component from a sol-gel approach in a much shorter time (a few minutes for RTN compared to several hours for the conventional nitridation process), implying that the process also requires less energy and gas. To conclude, this work demonstrated an affordable, effective, and practicable way to convert complex TiO<sub>2</sub> shapes into a pure TiN-structured material. Indeed, the processing time and the equipment required are fully compatible with most manufacturing processes, whereas the traditional ammonolysis process requires a lot of time, large quantities of consumables, and heavy equipment. The low film thickness of the TiN film obtained by this process may be presently a limitation for using such films as diffusion barriers in microelectronic devices. Thus, future developments may be focused in particular on obtaining thicker TiN films with similar characteristics. In spite of this limitation, this technology promises to achieve very high-quality TiN micro-nanostructured thin films, including on nonconventional substrates

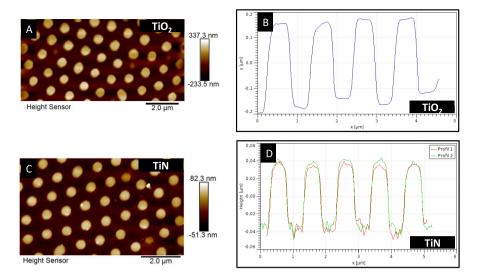


Figure 11. (A, B) AFM image and profile of nanostructured TiO<sub>2</sub> and (C, D) AFM image and profile of nanostructured TiN.

such as glass or plastic, even if the factor of temperature can be a strong limitation for thermo-sensitive materials.

## ASSOCIATED CONTENT

## **Supporting Information**

The Supporting Information is available free of charge at https://pubs.acs.org/doi/10.1021/acs.jpcc.0c07157.

Additional information on the AFM measurements of  ${\rm TiO_2}$  and  ${\rm TiN}$  thin films deposited on a  ${\rm SiO_2}$  substrate and description of the ellipsometry experimental setup (PDF)

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#### **Author Contributions**

This manuscript was written through contributions of all authors. All authors have given approval to the final version of the manuscript.

#### Notes

The authors declare no competing financial interest.

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